74LVC646A Octal bus transceiver/register; 3-state Rev. 5 – 28 March 2013

Product data sheet

1. General description

The 74LVC646A consists of non-inverting bus transceiver circuits with 3-state outputs, D-type flip-flops and control circuitry arranged for multiplexed transmission of data directly from the internal registers. Data on the A or B bus is clocked in the internal registers, as the appropriate clock (CPAB or CPBA) goes to a HIGH logic level. Output enable (\overline{OE}) and direction (DIR) inputs are provided to control the transceiver function. In the transceiver mode, data present at the high-impedance port may be stored in either the A or B register, or in both. With the select source inputs (SAB and SBA), stored and real-time (transparent mode) data can be multiplexed. The direction (DIR) input determines which bus receives data when \overline{OE} is active (LOW). In the isolation mode (\overline{OE} = HIGH), A data may be stored in the B register and/or B data may be stored in the A register. When an output function is disabled, the input function is still enabled and may be used to store and transmit data. Only one of the two buses A or B may be driven at a time.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V and 5 V applications.

2. Features and benefits

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Supply voltage range from 1.2 V to 3.6 V
- CMOS low-power consumption
- Direct interface with TTL levels
- 8-bit octal transceiver with D-type latch
- Back-to-back registers for storage
- Separate controls for data flow in each direction
- Supports partial power-down applications; inputs/outputs are high-impedance when V_{CC} = 0 V
- Complies with JEDEC standard:
 - JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C.

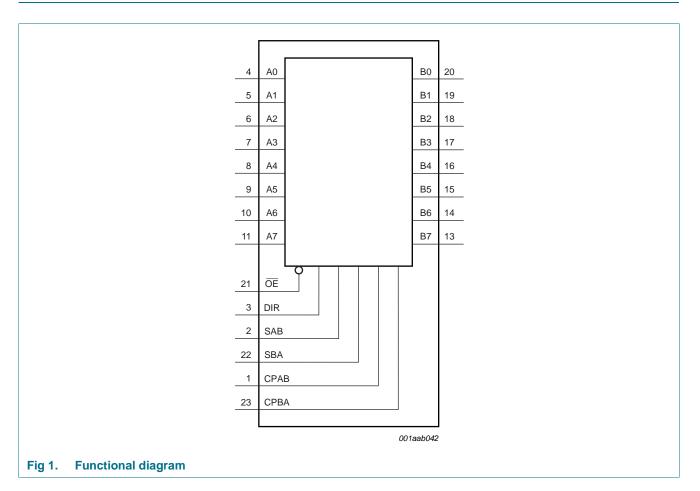


Octal bus transceiver/register; 3-state

3. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVC646AD	–40 °C to +125 °C	SO24	plastic small outline package; 24 leads; body width 7.5 mm	SOT137-1
74LVC646ADB	–40 °C to +125 °C	SSOP24	plastic shrink small outline package; 24 leads; body width 5.3 mm	SOT340-1
74LVC646APW	–40 °C to +125 °C	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-1

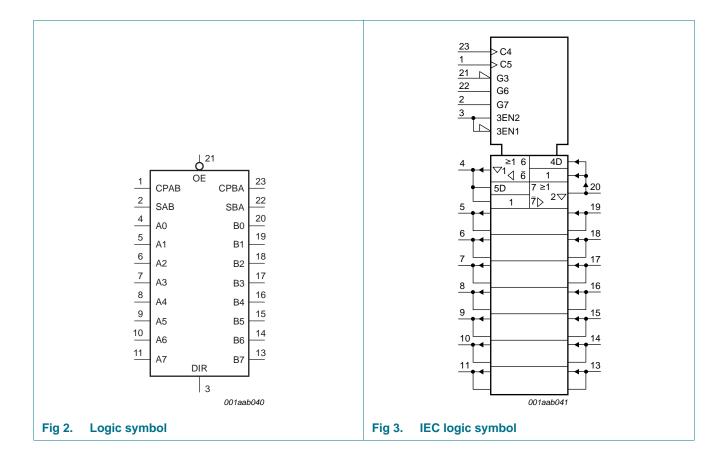
4. Functional diagram



Product data sheet

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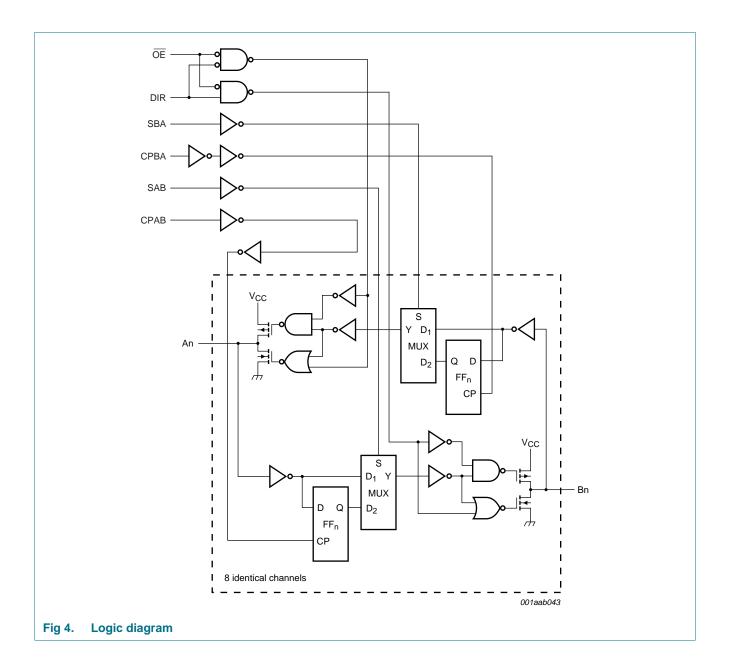
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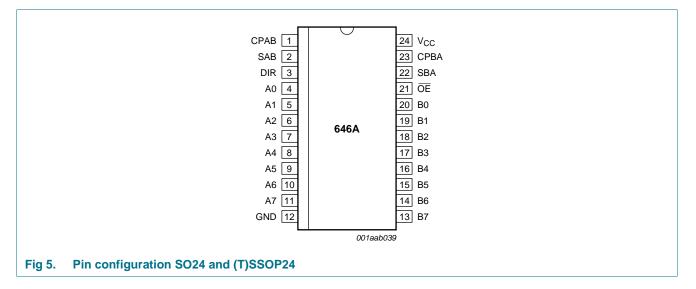
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5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
CPAB	1	A to B clock input (LOW to HIGH; edge-triggered)
SAB	2	A to B select source input
SBA	22	B to A select source input
DIR	3	direction control input
A[0:7]	4, 5, 6, 7, 8, 9, 10, 11	A data input/output
B[0:7]	20, 19, 18, 17, 16, 15, 14, 13	B data input/output
OE	21	output enable input (active LOW)
CPBA	23	B to A clock input (LOW to HIGH, edge-triggered)
GND	12	ground (0 V)
V _{CC}	24	supply voltage

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6. Functional description

Table 3. Function table^[1]

Input	nput				Data I/O		Function	
OE	DIR	CPAB	СРВА	SAB	SBA	A0 to A7	B0 to B7	
Х	Х	↑	Х	Х	Х	input	unspecified ^[2]	store A and B unspecified
Х	Х	Х	\uparrow	Х	Х	unspecified ^[2]	input	store B and A unspecified
Н	Х	\uparrow	\uparrow	Х	Х	input	input	store A and B data
Н	Х	H or L	H or L	Х	Х	input	input	hold storage; isolation
L	L	Х	Х	Х	L	output	input	real-time B data to A bus
L	L	Х	H or L	Х	Н	output	input	stored B data to A bus
L	Н	Х	Х	L	Х	input	output	real-time A data to B bus
_	Н	H or L	Х	Н	Х	input	output	stored A data to B bus

[1] H = HIGH voltage level

L = LOW voltage level

X = don't care

 \uparrow = LOW to HIGH level transition

[2] The data output functions are enabled or disabled by various signals at the OE and DIR inputs. Data input functions are always enabled, i.e. data at the bus inputs are stored on every LOW to HIGH transition on the clock inputs.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Unit
V
mA
V
mA
V
V
mA
mA
mA
°C
mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

For SO24 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K.
 For (T)SSOP24 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K.

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8. Recommended operating conditions

Table 5.	Recommended operating condi	tions				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	HIGH or LOW state	0	-	V _{CC}	V
		3-state	0	-	5.5	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	V_{CC} = 1.65 V to 2.7 V	0	-	20	ns/V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	- 40 °	°C to +8	85 °C	-40 °C to	o +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
V _{IH}	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = 100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	-	-	0.2	-	0.3	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		I_{O} = 12 mA; V_{CC} = 2.7 V	-	-	0.4	-	0.6	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
lı	input leakage current	V _{CC} = 3.6 V; V _I = 5.5 V or GND	-	±0.1	±5	-	±20	μΑ
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Symbol	Parameter	Conditions		-40	°C to +85	S°C	–40 °C to	o +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
I _{OZ}	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 3.6 \text{ V};$ $V_{O} = 5.5 \text{ V or GND};$	[2]	-	0.1	±10	-	±20	μA
I _{OFF}	power-off leakage current	$V_{CC} = 0$ V; V_1 or $V_0 = 5.5$ V		-	0.1	±10	-	±20	μΑ
I _{CC}	supply current	V_{CC} = 3.6 V; V_{I} = V_{CC} or GND; I_{O} = 0 A		-	0.1	10	-	40	μA
ΔI_{CC}	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_{I} = V_{CC} - 0.6 V; I_{O} = 0 A$		-	5	500	-	5000	μA
CI	input capacitance	$V_{CC} = 0 V \text{ to } 3.6 V;$ $V_{I} = GND \text{ to } V_{CC}$		-	5.0	-	-	-	pF
C _{I/O}	input/output capacitance	$V_{CC} = 0 V$ to 3.6 V; $V_{I} = GND$ to V_{CC}		-	10.0	-	-	-	pF

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

[2] For transceivers, the parameter I_{OZ} includes the input leakage current.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 11.

Symbol	Parameter	Conditions		T _{amb} =	–40 °C to	+85 °C	–40 °C to	+125 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{pd}	propagation	An, Bn to Bn, An; see Figure 6	[2]						
	delay	$V_{CC} = 1.2 V$		-	17	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.8	6.9	15.8	1.8	18.2	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	3.7	8.2	1.5	9.4	ns
		$V_{CC} = 2.7 V$		1.5	3.6	7.8	1.5	10.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	3.1	6.8	1.0	8.0	ns
		CPAB, CPBA to Bn, An; see Figure 7	[2]						
		$V_{CC} = 1.2 V$		-	19	-	-	-	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		2.4	8.6	17.8	2.4	20.5	ns
		V_{CC} = 2.3 V to 2.7 V		1.7	4.5	9.1	1.7	10.5	ns
		$V_{CC} = 2.7 V$		1.5	4.1	8.6	1.5	11.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	3.8	7.6	1.0	9.5	ns
		SAB, SBA to Bn, An; see Figure 8	[2]						
		V _{CC} = 1.2 V		-	19	-	-	-	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		1.5	7.6	19.8	1.5	22.9	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	4.0	10.2	1.5	11.8	ns
		$V_{CC} = 2.7 V$		1.5	4.0	9.5	1.5	12.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	3.4	8.5	1.0	11.0	ns
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Symbol	Parameter	Conditions		T _{amb} =	–40 °C to	+85 °C	-40 °C to	o +125 °C	Unit
				Min	Typ[1]	Мах	Min	Max	
en	enable time	OE to An and Bn; see Figure 9	[2]						
		V _{CC} = 1.2 V		-	20	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		2.4	7.2	17.8	2.4	20.6	ns
		V_{CC} = 2.3 V to 2.7 V		2.0	4.1	9.8	2.0	11.3	ns
		$V_{CC} = 2.7 V$		1.5	4.2	8.8	1.5	11.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	3.3	7.8	1.0	10.0	ns
		DIR to An and Bn; see Figure 10	[2]						
		$V_{CC} = 1.2 V$		-	20	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		2.9	8.0	18.1	2.9	20.9	ns
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		2.4	4.5	9.9	2.4	11.5	ns
		$V_{CC} = 2.7 V$		1.5	4.2	8.9	1.5	11.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	3.6	7.9	1.0	10.0	ns
dis	disable time	OE to An and Bn; see Figure 9	[2]						
		$V_{CC} = 1.2 V$		-	10	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		3.6	5.0	10.4	3.6	12.0	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.8	5.9	1.0	6.8	ns
		$V_{CC} = 2.7 V$		1.5	3.6	7.1	1.5	9.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	3.3	6.1	1.0	8.0	ns
		DIR to An and Bn; see Figure 10	[2]						
		$V_{CC} = 1.2 V$		-	10	-	-	-	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		2.9	3.9	10.1	2.9	11.7	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.1	5.7	1.0	6.6	ns
		$V_{CC} = 2.7 V$		1.5	3.5	7.0	1.5	9.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	2.8	6.0	1.0	7.5	ns
^t w	pulse width	clock HIGH or LOW of CPAB or CPBA; see <u>Figure 7</u>							
		V _{CC} = 1.65 V to 1.95 V		5.0	-	-	5.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		4.0	-	-	4.0	-	ns
		$V_{CC} = 2.7 V$		3.3	-	-	3.3	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		3.3	1.9	-	3.3	-	ns
su	set-up time	An, Bn to CPAB, CPBA; see Figure 7							
		V _{CC} = 1.65 V to 1.95 V		3.5	-	-	3.5	-	ns
		V_{CC} = 2.3 V to 2.7 V		2.5	-	-	2.5	-	ns
		$V_{CC} = 2.7 V$		1.6	-	-	1.6	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	0.35	-	1.5	-	ns

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 11.

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Symbol	Parameter	Conditions		T _{amb} =	–40 °C to	• +85 °C	–40 °C to	o +125 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _h	hold time	An, Bn to CPAB, CPBA; see Figure 7							
		V_{CC} = 1.65 V to 1.95 V		3.0	-	-	3.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		2.0	-	-	2.0	-	ns
		$V_{CC} = 2.7 V$		1.0	-	-	1.0	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	-0.3	-	1.0	-	ns
f _{max}	maximum	see Figure 7							
	frequency	V_{CC} = 1.65 V to 1.95 V		100	-	-	80	-	MHz
		V_{CC} = 2.3 V to 2.7 V		125	-	-	100	-	MHz
		$V_{CC} = 2.7 V$		150	-	-	120	-	MHz
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		150	250	-	120	-	MHz
t _{sk(o)}	output skew time	V_{CC} = 3.0 V to 3.6 V	<u>[3]</u>	-	-	1.0	-	1.5	ns
C _{PD}	power	per input; $V_I = GND$ to V_{CC}	[4]						
	dissipation	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		-	8.0	-	-	-	pF
	capacitance	V_{CC} = 2.3 V to 2.7 V		-	11.7	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	15.0	-	-	-	pF

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 11</u>.

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

 t_{en} is the same as t_{PZL} and t_{PZH} .

 t_{dis} is the same as t_{PLZ} and $t_{\text{PHZ}}.$

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $\mathsf{P}_{\mathsf{D}} = \mathsf{C}_{\mathsf{P}\mathsf{D}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}^2 \times \mathsf{f}_i \times \mathsf{N} + \Sigma(\mathsf{C}_{\mathsf{L}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}^2 \times \mathsf{f}_o) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

 C_{L} = output load capacitance in pF

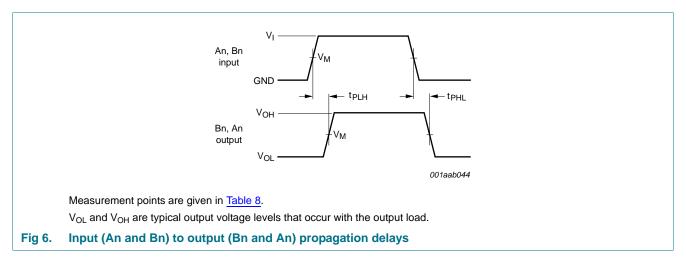
V_{CC} = supply voltage in Volts

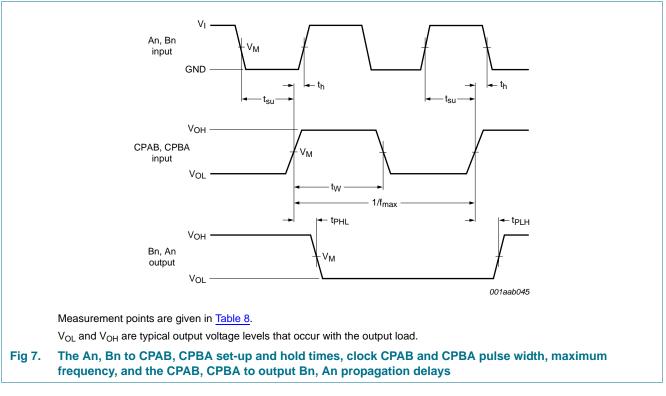
N = number of inputs switching

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs

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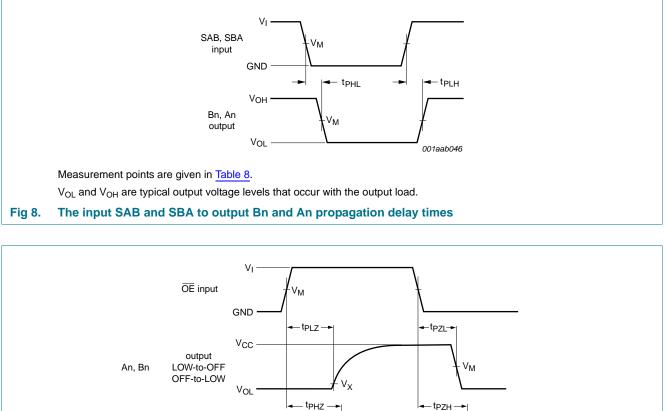
11. Waveforms

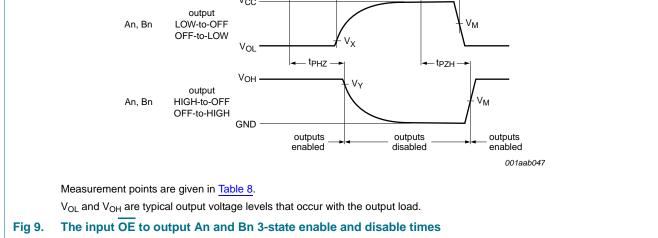




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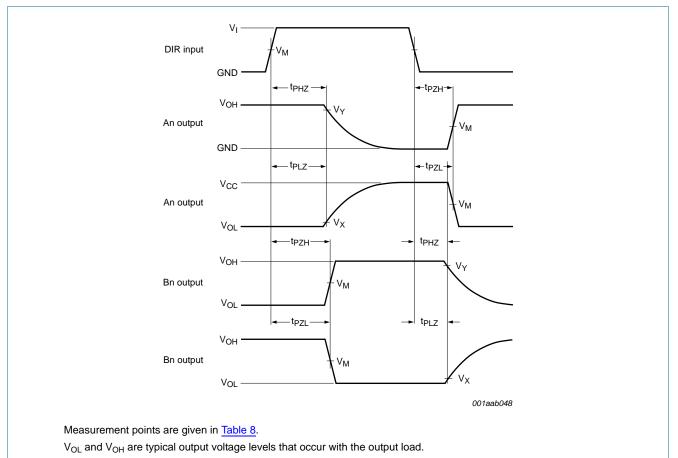


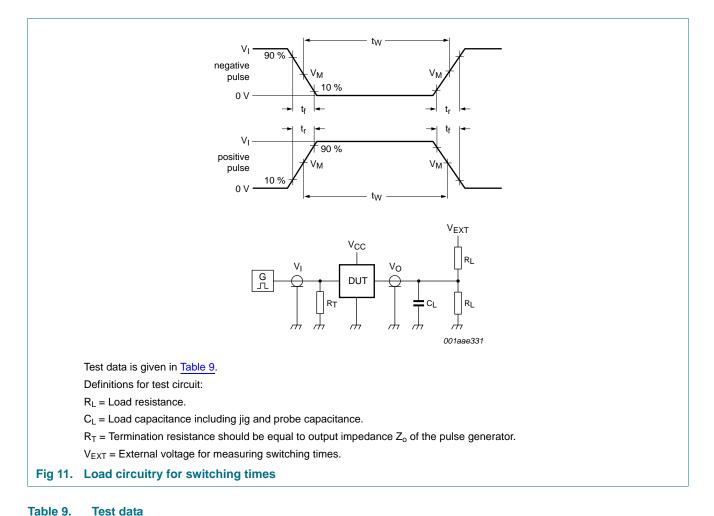
Fig 10. The input showing the input DIR to output An, Bn 3-state enable and disable times

Table 8. Measurement points

Supply voltage	Input		Output	Output				
V _{cc}	VI	V _M	V _M	V _X	V _Y			
1.2 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V			
1.65 V to 1.95 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V			
2.3 V to 2.7 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V			
2.7 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V			
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V			

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Supply voltage	Input	Input			V _{EXT}	V _{EXT}		
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND	
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND	

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12. Application information

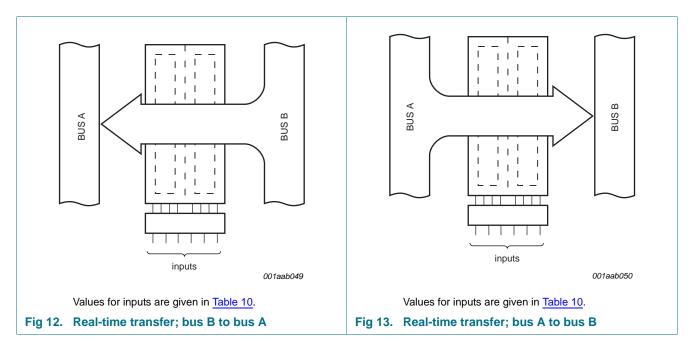


Table 10. Real-time transfer^[1]

Direction	Input					
	OE	DIR	СРАВ	СРВА	SAB	SBA
Bus B to bus A	L	L	Х	Х	Х	L
Bus A to bus B	L	Н	Х	Х	L	Х

[1] H = HIGH voltage level;

L = LOW voltage level;

X = don't care

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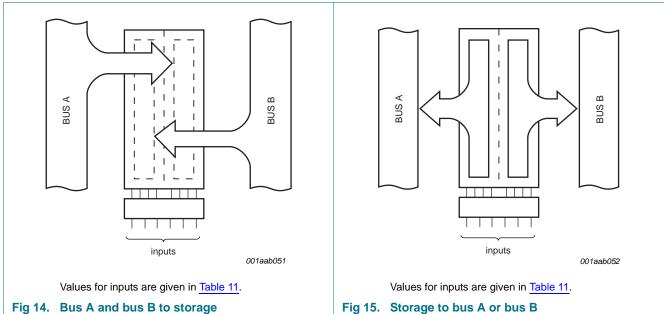


Fig 14. Bus A and bus B to storage

Table 11. Storage transfer[1]

Function	Input					
	OE	DIR	CPAB	СРВА	SAB	SBA
Bus A to storage	x	Х	\uparrow	Х	Х	Х
Bus B to storage	Х	Х	Х	\uparrow	Х	Х
Bus A and B to storage	Н	Х	↑	\uparrow	Х	Х
Storage to bus A	L	L	Х	H or L	Х	Н
Storage to bus B	L	Н	H or L	Х	Н	Х

[1] H = HIGH voltage level

L = LOW voltage level

X = don't care

 \uparrow = LOW to HIGH level transition

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13. Package outline

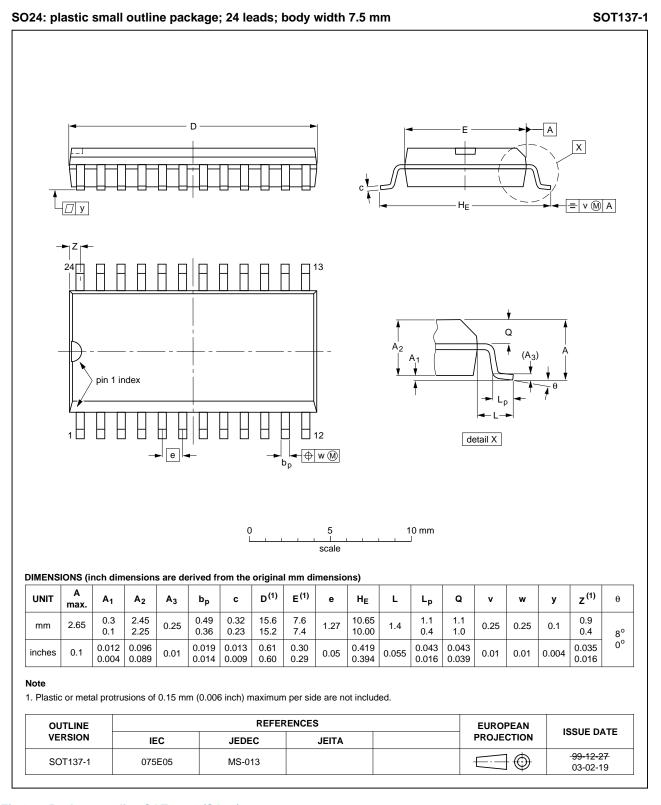


Fig 16. Package outline SOT137-1 (SO24)

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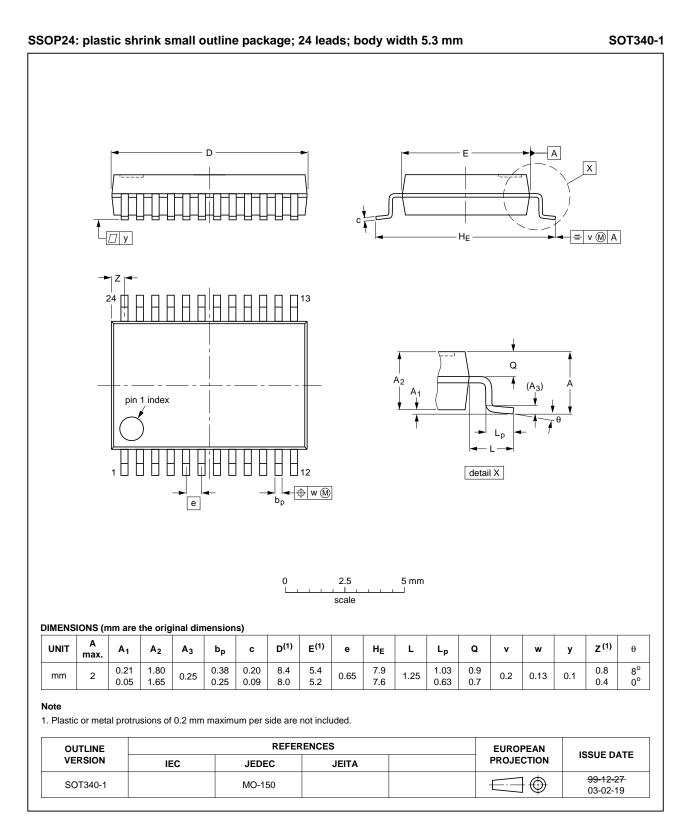


Fig 17. Package outline SOT340-1 (SSOP24)

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Product data sheet

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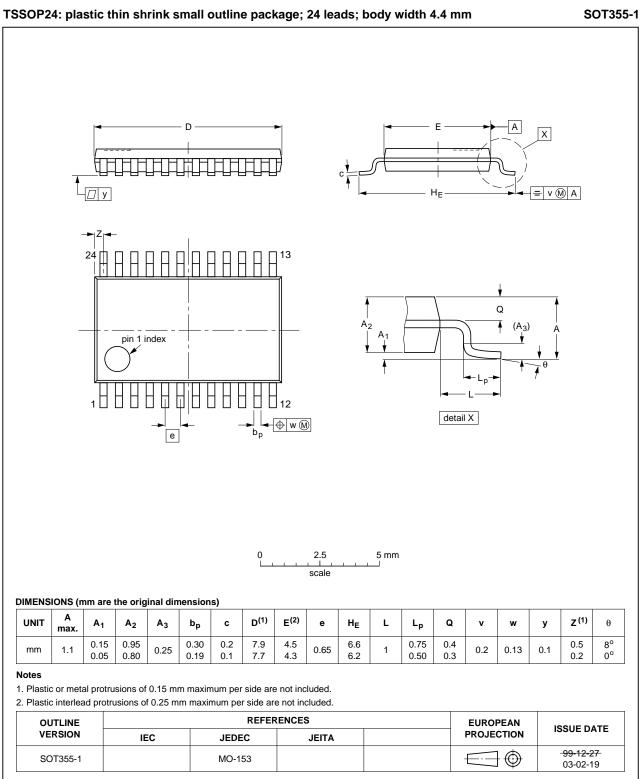


Fig 18. Package outline SOT355-1 (TSSOP24)

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14. Abbreviations

Description
Charged Device Model
Device Under Test
ElectroStatic Discharge
Human Body Model
Transistor-Transistor Logic
Machine Model

15. Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC646A v.5	20130328	Product data sheet	-	74LVC646A v.4
Modifications:	 The format of of NXP Semic 		lesigned to comply wit	h the new identity guidelines
	 Legal texts have 	ve been adapted to the new	company name where	e appropriate.
	• Table 4, Table	5, <u>Table 6, Table 7, Table 8</u>	and <u>Table 9</u> : values ac	ded for lower voltage ranges.
74LVC646A v.4	20040629	Product specification	-	74LVC646A v.3
74LVC646A v.3	20000621	Product specification	-	74LVC646A v.2
74LVC646A v.2	19980729	Product specification	-	74LVC646A v.1
74LVC646A v.1	19980325	Product specification	-	-

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16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Product data sheet

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